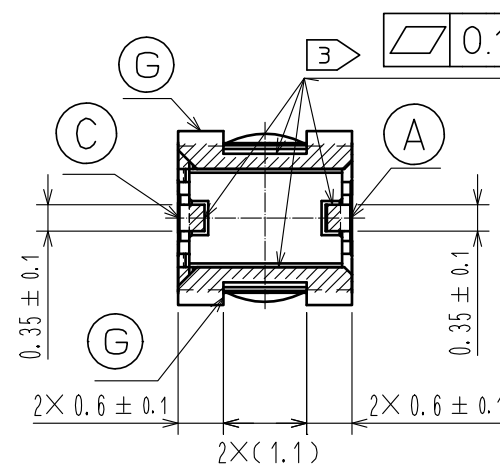
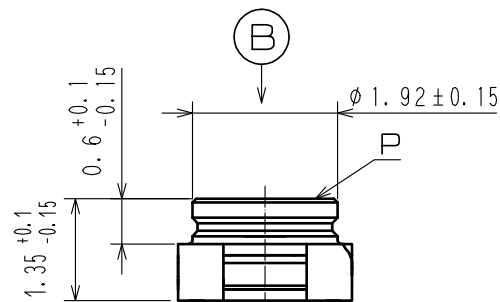
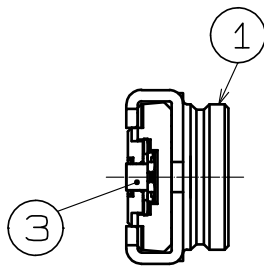
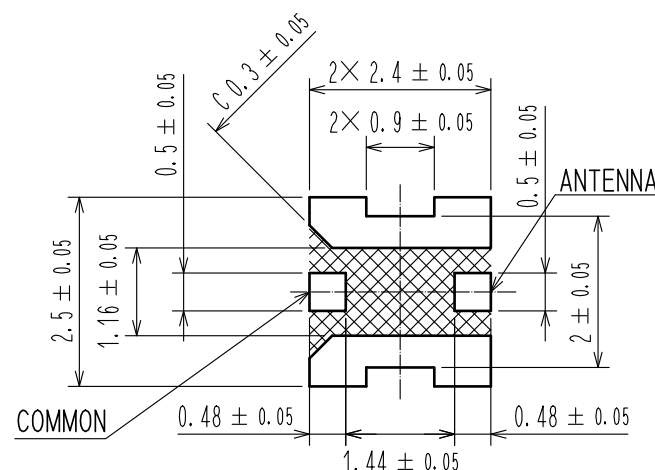


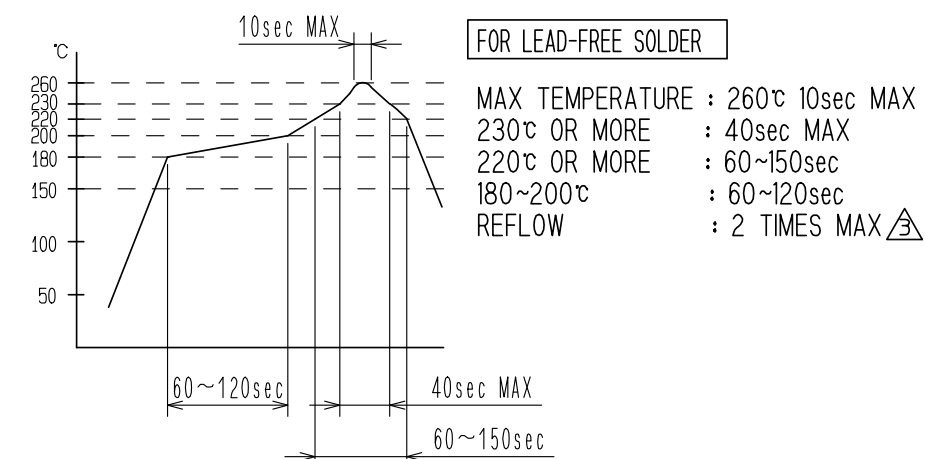
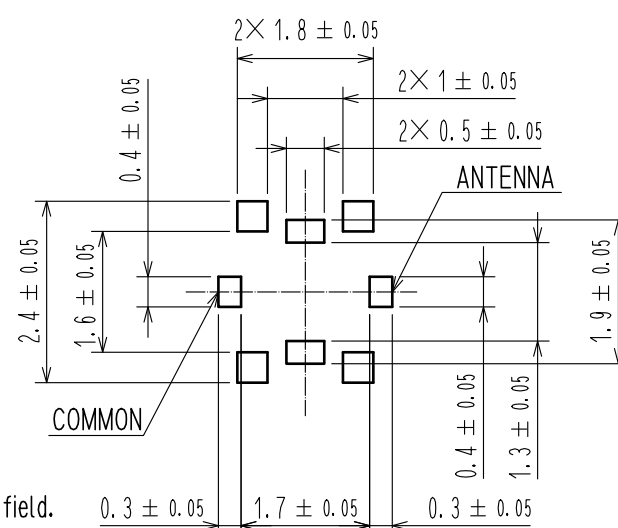


5 SPECIFIED PCB LAYOUT

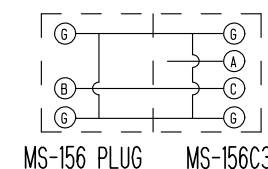
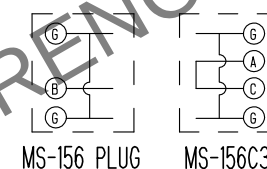
5 SPECIFIED STENCIL PLATE
THICKNESS: 0.1mm



 :This area must be free of conductive traces and resist field.



NOTE 1. Circuit shall be as follows.



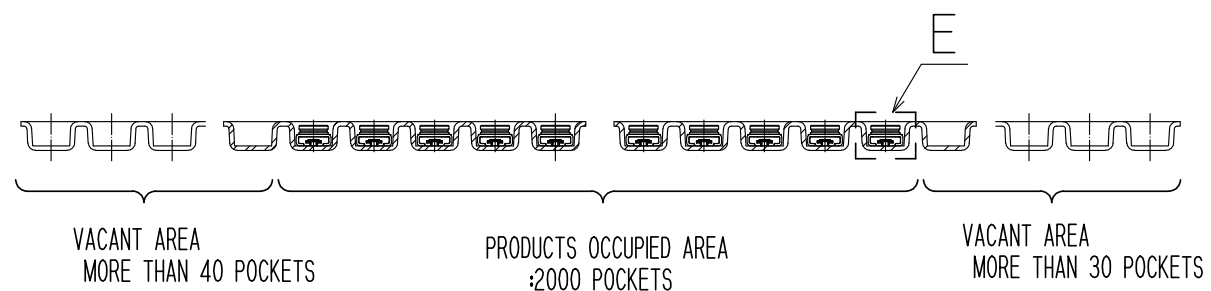
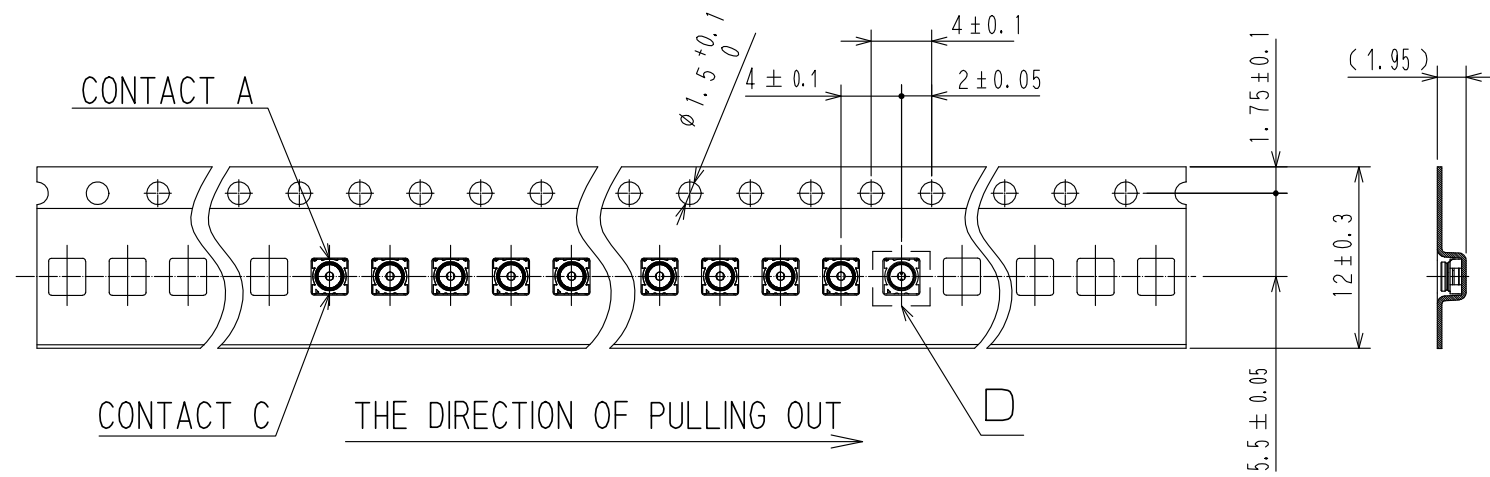
2. For use of this product, be sure to put contact area of plug on position P perpendicularly.
3. Lead co-planarity is to be 0.1mm MAX.
4. Do not use the washing process.
5. Please do not change the specified layout of the PCB dimension and the layout of the stencil plate dimension and thickness otherwise could not be responsible for the solderability of the product.
6. This product is intended to be used for circuit inspection only. Consult us if any other application is considered.
7. Do not use hand soldering for mounting of MS-156C3.

HALOGEN FREE COMPLIANT

3	CU-NI-SI-ALLOY	SELECTIVE GOLD PLATING	6	PET	
2	PA-M		5	PS	
1	PHOSPHOR BRONZE	GOLD PLATING	4	PHOSPHOR BRONZE	SELECTIVE GOLD PLATING
NO.	MATERIAL	FINISH . REMARKS	NO.	MATERIAL	FINISH . REMARKS

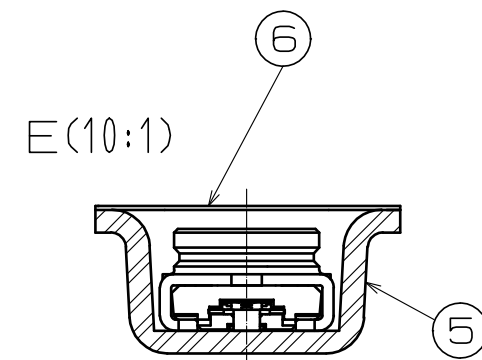
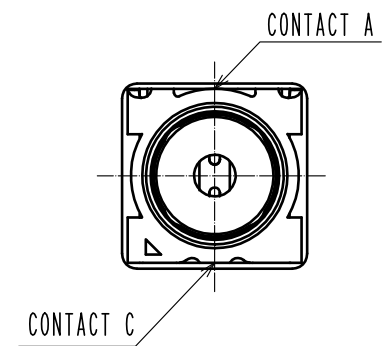
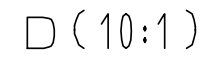
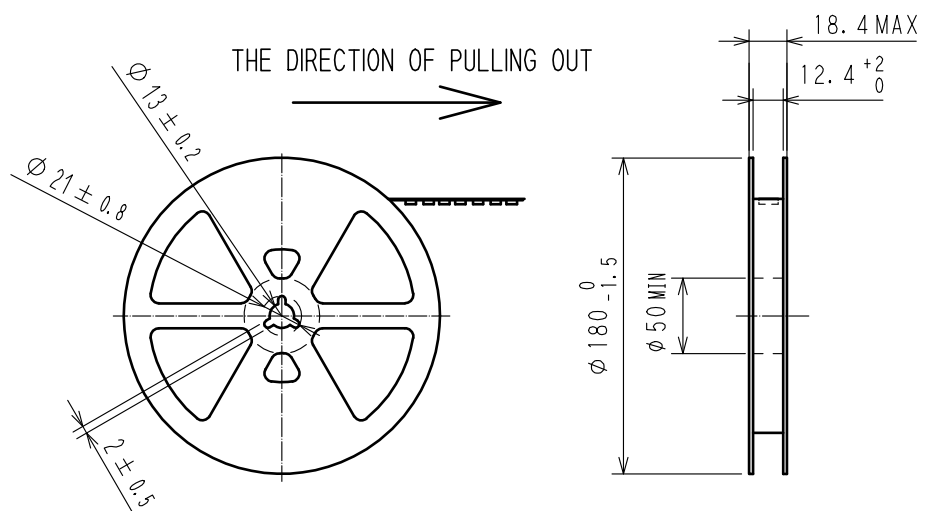
UNITS mm		SCALE 10 : 1	COUNT 1	DESCRIPTION OF REVISIONS DIS-D-00014617	DESIGNED MT. KANEKO	CHECKED NK. NINOMIYA	DATE 20230124
 HIROSE ELECTRIC CO., LTD.		APPROVED	•MH. YAMANE	20140327	DRAWING NO. EDC3-350543-20		
		CHECKED	•NK. NINOMIYA	20140327			
		DESIGNED	•TS. NAKAGAWA	20140326	PART NO. MS-156C3(20)		
		DRAWN	•TS. NAKAGAWA	20140326			
					CODE NO.	CL0358-0340-0-20	 1

PACKAGING SPECIFICATION

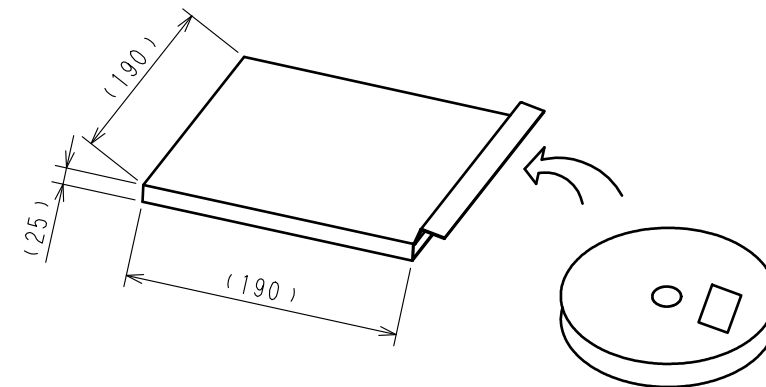


REEL DIMENSIONS(FREE)

2000 PIECES PER REEL



OUTER PACKAGING CASE(FREE)



DRAWING NO.	EDC3-350543-20		
PART NO.	MS-156C3(20)		
CODE NO.	CL0358-0340-0-20		